

In the Claims

Please **SUBSTITUTE** the following amended claims for the pending claims with the same number (a marked up copy of the prior pending claim with all changes shown is supplied in the appendix):

a1
6. The computing device as recited in claim 5 wherein the structural glue is arranged to structurally attach the structural elements of the first and second members, and wherein the conductive paste is arranged to electrically connect the conductive elements of the first and second members.

a2
20. A component of a computer enclosure comprising:
a first member having a first conductive surface;
a second member having a second conductive surface; and
a conductive bridge electrically bonding the first and second conductive surfaces and electrically sealing an interface between the first and second conductive surfaces so as to form a singular conductive structure for shielding electronic emissions.

Please **ADD** the following claims (57-60):

a3
57. (New) A computing device, comprising:
a first structural member having a first conductive portion;
a second structural member having a second conductive portion; and
a joint configured to electrically bond the first and second conductive portions together and to structurally attach the first and second structural members together.

a4
58. (New) The computing device as recited in claim 57 wherein the joint is rigid.

59. (New) The computing device as recited in claim 57 wherein the first and second conductive portions are bonded together in order to form a singular conductive structure for shielding electronic emissions.

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work*

60. (New) The computing device as recited in claim 57 wherein the first and second structural members are attached together in order to form a single composite structure for housing at least a portion of the computing device.
